# 2SA1738

# Silicon PNP epitaxial planer type

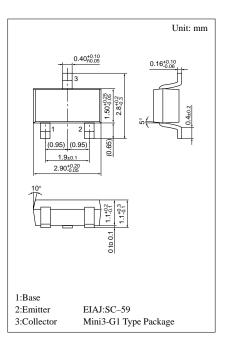
For high speed switching

### Features

- High-speed switch (pair with 2SC3757)
- Low collector to emitter saturation voltage V<sub>CE(sat)</sub>.
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	-15	V
Collector to emitter voltage	V <sub>CEO</sub>	-15	V
Emitter to base voltage	V <sub>EBO</sub>	-4	V
Peak collector current	I <sub>CP</sub>	-100	mA
Collector current	I <sub>C</sub>	-50	mA
Collector power dissipation	P <sub>C</sub>	200	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 ~ +150	°C

### Absolute Maximum Ratings (Ta=25°C)



Marking symbol : AK

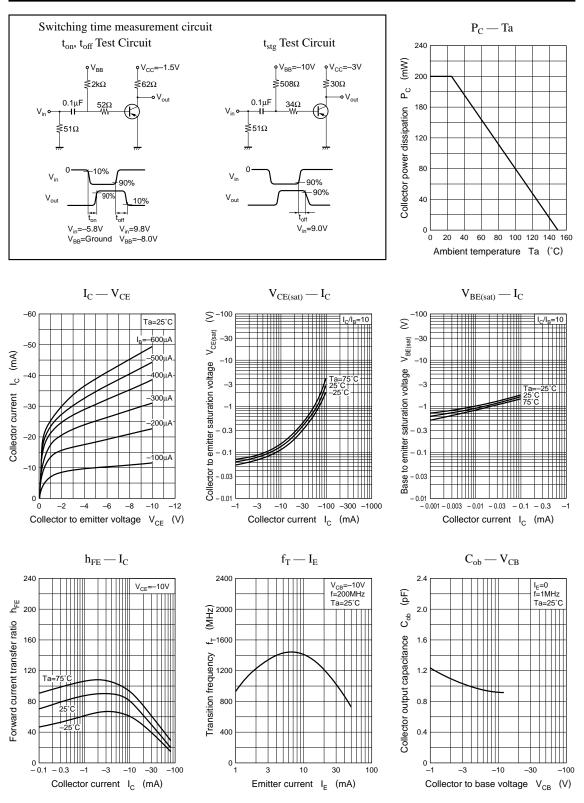
# Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = -8V, I_E = 0$			- 0.1	μA
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -3V, I_C = 0$			- 0.1	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = -1V, I_C = -10mA$	50		150	
	h <sub>FE2</sub>	$V_{CE} = -1V, I_C = -1mA$	30			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = -1 {\rm mA}$		- 0.1	- 0.2	v
Transition frequency	f <sub>T</sub>	$V_{CB} = -10V, I_E = 10mA, f = 200MHz$	800	1500		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -5V, I_E = 0, f = 1MHz$		1		pF
Turn-on time	t <sub>on</sub>	(Note 1) Next page		12		ns
Turn-off time	t <sub>off</sub>	(Note 1) Next page		20		ns
Storage time	t <sub>stg</sub>	(Note 1) Next page		19		ns

#### \*hFE1 Rank classification

Rank	Q	R
h <sub>FE1</sub>	50 ~ 120	90 ~ 150

# Transistor



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